# **AW312A Datasheet**

# Zhuhai Jieli Technology Co.,LTD

Version 1.0

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# **Revision History**

Date	Revision	Description
2024.04.12	V1.0	Initial Release





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### **AW312A Features**

#### **SYSTEM**

- 32bit CPU 160MHz
- ➤ Support MATH/AES128
- I-cache
- Support EMU
- On-chip SRAM 32kbyte
- Support MPU
- Support UDMA
- ➢ Built-In Flash
- ➤ 24MHz crystal oscillator
- > Internal low jitter low power RC oscillator
- Internal PLL

#### **Bluetooth**

- BLE5.4 +2.4GHz-Proprietary (QDID 223418)
- Support AoA Transmitter
- Support long range BLE
- Maximum transmitting power 9dBm
- Receiver sensitivity
  - ◆ -93dBm @BLE-1Mbps
  - ◆ -90dBm @BLE-2Mbps

### **Peripherals**

- 1 x Full speed USB
- 4 x Multi-function 32bit timer
- ➤ 1 x IR RX/TX
- 3 x UART interface
- 1 x I<sup>2</sup>C Master/Slave interface
- 2 x SPI Master/Slave interface
- ➤ 1 x QDEC
- ➤ 4 x MCPWM
- ➤ 2 x LEDC
- ➤ 1 x 10bit ADC(11 Channel)
- 10 x GPIO Support function remapping

#### **PMU**

- Support temperature sensor
- ➤ VPWR range 2.7V to 5.5V
- IOVDD range 1.8V to 3.6V
- > Deep sleep mode (IOVDD @3.0V)
  - 170nA (External wakeup)
  - 1.37uA (32kHz RC OSC+wakeup)
  - 2.9uA (32kHz RC OSC+wakeup+16k retention SRAM)

#### **Packages**

➤ SOP16

#### **Temperature**

- Operating temperature
  - TC =  $-20^{\circ}$ C to  $+85^{\circ}$ C (standard range)
  - $TC = -40^{\circ}C$  to  $+105^{\circ}C$  (extended range)
- Storage temperature -65°C to +150°C

#### **Applications**

- Mouse devices
- Non-audio remote controller
- Selfie stick
- Page turner
- Adaptive USB
- Bluetooth moudle
- Price tag and other diversified IOT product



# 1 Block Diagram

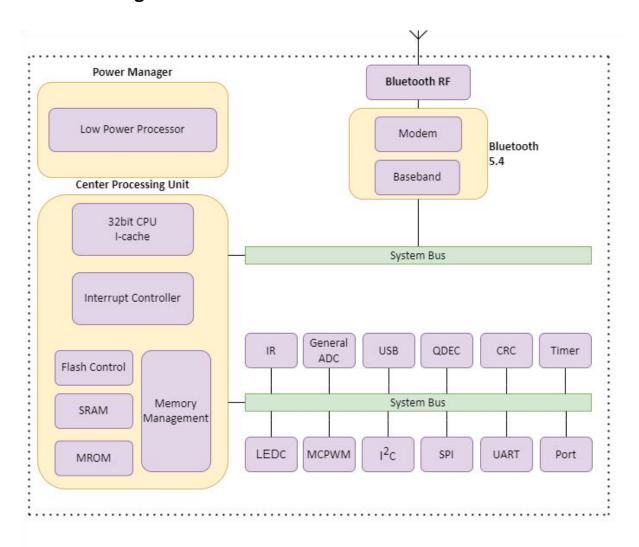


Figure 1-1 AW312A Block Diagram



### 2 Pin Definition

### 2.1 Pin Assignment

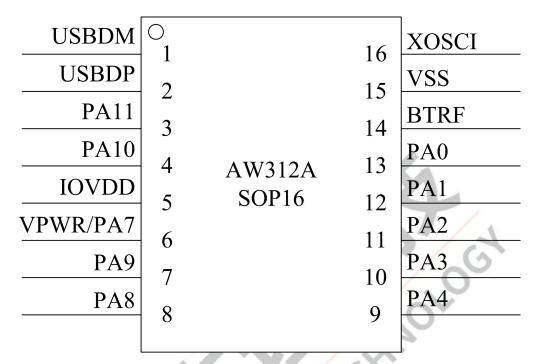


Figure 2-1 AW312A Pin Assignment



### 2.2 Pin Description

Table 2-2-1 AW312A Pin Description

Pin No.	Name	Туре	IO Initial State	Description
1	USBDM	1/0	15kΩ Pull-down	ADC13(ADC Input Channel 13)
2	USBDP	1/0	15kΩ Pull-down	ADC14(ADC Input Channel 14)
3	PA11	1/0	10kΩ Pull-up	ADC11(ADC Input Channel 11) Hold down 0 to reset
4	PA10	1/0	Z	ADC10(ADC Input Channel 10)
5	IOVDD	Р		IO Power
	VPWR	Р		Battery Input
6	PA7	1/0	Z	X
7	PA9	1/0	Z	LVD(External Low Voltage Detection Input) ADC9(ADC Input Channel 9) SPIO_DAT3B
8	PA8	1/0	Z	ADC8(ADC Input Channel 8) SPI0_DAT2B
9	PA4	1/0	10kΩ Pull-up	ADC4(ADC Input Channel 4)  MCLR(Device Reset)
10	PA3	1/0	z	ADC3(ADC Input Channel 3) SPIO_DIB(1)
11	PA2	1/0	Z	ADC2(ADC Input Channel 2) SPIO_DOB(0)
12	PA1	1/0	Z	ADC1(ADC Input Channel 1) SPIO_CLKB
13	PA0	1/0	Z	ADC0(ADC Input Channel 0)
14	BTRF	RF	-	Bluetooth RF Antenna
15	VSS	G	-	Ground
16	XOSCI	I.		Crystal Oscillator Input

#### Note

1.IO initial state abbreviations Z--High resistance, H--High level, L--Low level, X--May be changed during power on.

2.Timer, IR,MCPWM, QDEC, UART, LEDC, I<sup>2</sup>C, SPI1 functions can be remapped to any I/O.

**Table 2-2-2 Pin Types Description** 

Pin Type	Description	Pin Type	Description
Р	Power	1/0	Input or Output
G	Ground	Į	Input
RF	RF antenna	0	Output

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### 3 Electrical Characteristics

### 3.1 Absolute Maximum Ratings

**Table 3-1 Absolute Maximum Ratings** 

Symbol	Parameter	Min	Max	Unit
Topt	Operating temperature	-20	+85	$^{\circ}$
Tstg	Storage temperature	-65	+150	$^{\circ}$
VPWR	Cupality Voltage	-0.3	6.0	V
IOVDD	Supply Voltage	-0.3	3.6	V
GPIO	Input voltage of GPIO (except PA7)	-0.3	3.6	V
HVTIO	Input voltage of HVT-IO (PA7)	-0.3	6.0	V

### Note

# 3.2 ESD Ratings

**Table 3-2 ESD Ratings** 

Parameter	Тур	Test pin	Reference standard
Human Body Mode	±8kV	All pins	JEDEC EIA/JESD22-A114
Machine Mode	±400V	All pins	JEDEC EIA/JESD22-A115
Charge Device Model	±2kV	All pins	ANSI/ESDA/JEDEC JS-002-2022

### 3.3 PMU Characteristics

Table 3-3-1 PMU Characteristics under VPWR supply

· · · · · · · · · · · · · · · · · · ·						
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VPWR	Power supply	-	2.7		5.5	V
Operating mod	de					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
10)/DD	Voltage output			3.0		V
IOVDD	Loading current	IOVDD=3.0V@VPWR = 3.7V			60	mA
Low Power mo	ode					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
IOVDD	Loading current	IOVDD=3.0V@VPWR = 3.7V	-		8	mA

Table 3-3-2 PMU Characteristics under IOVDD supply

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
IOVDD	Power supply		1.8		3.6	V

<sup>1.</sup>Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device.



### 3.4 IO Characteristics

**Table 3-4 IO Characteristics** 

Input Chai	acteristics					
Symbol	Parameter	Conditions	10	Min	Max	Unit
			PA0~PA4			
$V_{IL}$	Low-Level Input Voltage	IOVDD = 3.0V	PA7~PA11	-0.3	1.4	V
			PA0~PA4			
		101/00 3 01/	PA8~PA11	4.7	2.2	.,
$V_{IH}$	High-Level Input Voltage	IOVDD = 3.0V	USBDP	1.7	3.3	V
			USBDM			
		IOVDD = 3.0V	PA7	1.7	5.5	V
Output Ch	aracteristics					
Symbol	Parameter	Conditions	10	Т	ур	Unit
lo <sub>L</sub>	Output Current	IOVDD = 3.0V Voutput = 0.3V	PA0~PA4 PA8~PA11	9(H 21(F	D=0) D=1) HD=2) HD=3)	mA
		IOVDD = 3.0V Voutput = 0.3V	PA7 USBDP USBDM	8		mA
І <sub>он</sub>	Output Current	IOVDD = 3.0V Voutput = 2.7V	PA0~PA4 PA8~PA11	3(HD=0) 9(HD=1) 21(HD=2) 54(HD=3)		mA
		IOVDD = 3.0V Voutput = 2.7V	PA7 USBDP USBDM	8		mA
	esistance Characteristics					
Symbol	Parameter	Conditions	10		ур	Unit
			PA0~PA4		PU=1)	
		IOVDD = 3.0V	PA7~PA11		(PU=2)	Ω
R <sub>pu</sub>	Pull-up Resistance				PU=3)	
		IOVDD = 3.0V	USBDP		.5k	Ω
		IOVDD = 3.0V	USBDM		30k	Ω
			PA0~PA4		PD=1)	
$R_pd$		IOVDD = 3.0V	PA7~PA11		(PD=2)	Ω
	Pull-down Resistance			1M(I	PD=3)	
		IOVDD = 3.0V	USBDP	15k		Ω
		3.00	USBDM			

#### Note

1.Internal pull-up/pull-down resistance accuracy ±20%.



### 3.5 BT Characteristics

### 3.5.1 Transmitter

**Table 3-5-1 Transmitter characteristics** 

Parameter	Conditions	Min	Тур	Max	Unit
Maximum RF Transmit Power	BLE-1Mbps		8	9	dBm

### 3.5.2 Receiver

**Table 3-5-2 Receiver characteristics** 

Parameter	Conditions	Min	Тур	Max	Unit
Sensitivity	BLE-1Mbps		-93		dBm
	BLE-2Mbps	//	-90		dBm
	BLE-S2		-96		dBm
	BLE-S8		-101	//	dBm





# 4 Package Information

### 4.1 SOP16

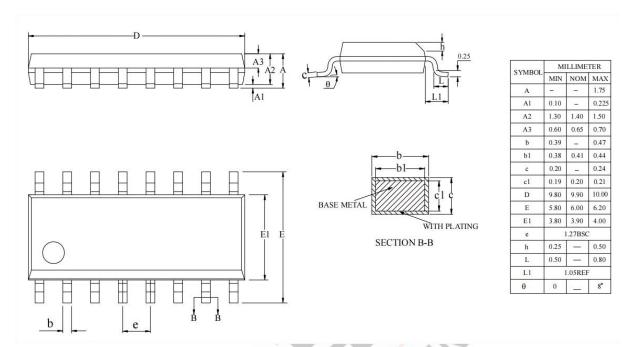


Figure 4-1 AW312A Package



## 5 IC Marking Information

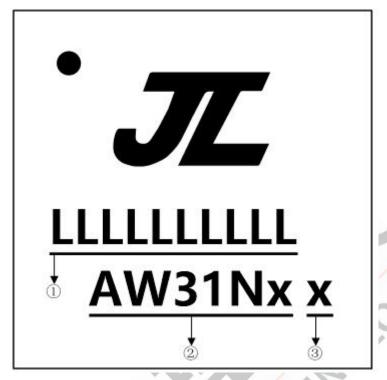


Figure 5-1 AW312A Package Outline

- 1 LLLLLLLL Production Batch
- 2 AW31Nx Chip Model
- 3 x Built-in flash size
  - 0 No Flash Memory
  - 2 2Mbit Flash
  - 4 4Mbit Flash



### 6 Solder-Reflow Condition

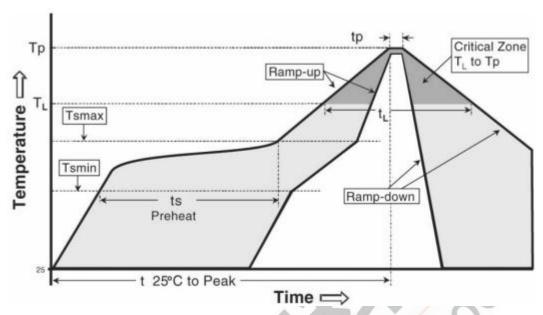


Figure 6-1 Classification Reflow Profile

**Table 6-1 Classification Profiles** 

	Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
	Temperature Min (T <sub>smin</sub> )	100℃	150℃
Preheat/Soak	Temperature Max (T <sub>smax</sub> )	150°C	200℃
	Time (ts) from (T <sub>smin</sub> to T <sub>smax</sub> )	60-120 seconds	60-180 seconds
Average ramp-	up rate (T <sub>smax</sub> to T <sub>p</sub> )	3℃/second max	3℃/second max
Liquidus temperature (T <sub>L</sub> )		183℃	217℃
Time (t <sub>L</sub> ) maint	ained above T∟	60-150 seconds	60-150 seconds
Peak package b	ood <mark>y temperature (T<sub>p</sub>)</mark>	See Table 6-2	See Table 6-3
Time within 5°0	C of actual	10-30 seconds	20-40 seconds
Peak Temperature (tp) <sup>2</sup>		10-50 Seconds	20-40 seconds
Ramp-down rate $(T_p \text{ to } T_L)$		6℃/second max	6℃/second max
Time 25℃ to p	eak temperature	6 minutes max	8 minutes max

#### Note

- 1.All temperatures refer to topside of the package, measured on the package body surface
- 2.Time within 5  $^{\circ}$ C of actual peak temperature (tp) specified for the reflow profiles is a "supplier" and "user" maximum.

**Table 6-2 SnPb Classification Temperature** 

Package	Volume mm <sup>3</sup>	Volume mm³
Thickness	< 350	≥ 350
<2.5 mm	240 +0/-5℃	225 +0/-5°C
≥2.5 mm	225 +0/-5℃	225 +0/-5°C



**Table 6-3 Pb-free - Classification Temperature** 

Package	Volume mm³	Volume mm³	Volume mm <sup>3</sup>
Thickness	< 350	350 - 2000	> 2000
< 1.6mm	260℃	260℃	<b>260</b> ℃
1.6 mm - 2.5mm	260℃	250℃	245℃
> 2.5mm	250℃	245℃	245℃

#### Note

1.\*Tolerance The device manufacturer/supplier shall assure process compatibility up to and including the stated classification temperature (this means Peak reflow temperature +0  $^{\circ}$ C.For example 260  $^{\circ}$ C+0  $^{\circ}$ C)at the rated MSL level.

